ROHS

Surface Mount Resettable PTCs

Description

The SMD0805L Series PTC provides surface mount over-current protection for applications where space is at a premium and reset table protection is desired.

Features

- ◆ RoHS compliant, Lead-Free and Halogen-Free
- ◆ Faster tripping, 0805L Dimension
- ◆ Compact design saves board space
- ◆ Compatible with high temperature solders
- ◆ Agency recognition: UL
- ◆ Low-profile

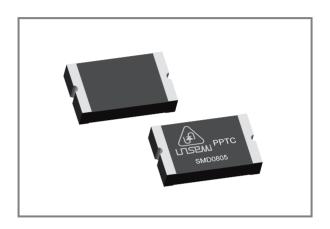
Applicable

- ◆ Battery PCM
- ◆ PDAs & Charger, Analog & digital line card
- Digital cameras
- General electronics
- ♦ USB peripherals
- Power ports

Electrical Parameters



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| Part Number | Marking | I hold | I trip | V max | I max | Pdtyp. | Maximu To | | Resis | tance |
|-------------------|---------|--------|--------|-------|-------|--------|----------------|----------------|-----------|---------------|
| i artivumbei | Warking | (A) | (A) | (Vdc) | (A) | (W) | Current (A) | Time (Sec.) | R min (Ω) | R 1max (Ω) |
| SMD0805-075L | Α | 0.75 | 1.5 | 6.0 | 50.0 | 0.7 | 8.0 | 1.0 | 0.060 | 0.300 |
| SMD0805-075L /12V | Α | 0.75 | 1.5 | 12.0 | 50.0 | 0.7 | 8.0 | 1.0 | 0.060 | 0.300 |
| SMD0805-110L | D | 1.1 | 2.2 | 6.0 | 50.0 | 0.7 | 8.0 | 1.0 | 0.018 | 0.110 |
| SMD0805-110L /12V | D | 1.1 | 2.2 | 12.0 | 50.0 | 0.7 | 8.0 | 1.0 | 0.018 | 0.110 |
| SMD0805-125L | D | 1.25 | 2.5 | 6.0 | 50.0 | 0.7 | 8.0 | 1.0 | 0.016 | 0.100 |
| SMD0805-125L /12V | D | 1.25 | 2.5 | 12.0 | 50.0 | 0.7 | 8.0 | 1.0 | 0.016 | 0.100 |
| SMD0805-150L | Е | 1.5 | 3.0 | 6.0 | 50.0 | 0.7 | 8.0 | 1.0 | 0.008 | 0.065 |
| SMD0805-150L /12V | Е | 1.5 | 3.0 | 12.0 | 50.0 | 0.7 | 8.0 | 1.0 | 0.008 | 0.065 |
| SMD0805-175L | E | 1.75 | 3.5 | 6.0 | 50.0 | 0.7 | 8.75 | 2.0 | 0.008 | 0.055 |
| SMD0805-175L /12V | Е | 1.75 | 3.5 | 12.0 | 50.0 | 0.7 | 8.75 | 2.0 | 0.008 | 0.055 |
| SMD0805-200L | E | 2.0 | 4.0 | 6.0 | 50.0 | 0.7 | 10.0 | 2.0 | 0.006 | 0.045 |
| SMD0805-200L /12V | E | 2.0 | 4.0 | 12.0 | 50.0 | 0.7 | 10.0 | 2.0 | 0.006 | 0.045 |
| SMD0805-260L | Н | 2.6 | 5.2 | 6.0 | 50.0 | 0.7 | 13.0 | 2.0 | 0.003 | 0.035 |
| SMD0805-260L /12V | Н | 2.6 | 5.2 | 12.0 | 50.0 | 0.7 | 13.0 | 2.0 | 0.003 | 0.035 |
| SMD0805-300L | Н | 3.0 | 6.0 | 6.0 | 50.0 | 0.8 | 15.0 | 2.0 | 0.003 | 0.030 |
| SMD0805-300L /12V | Н | 3.0 | 6.0 | 12.0 | 50.0 | 0.8 | 15.0 | 2.0 | 0.003 | 0.030 |
| SMD0805-350L | K | 3.5 | 7.0 | 6.0 | 50.0 | 0.8 | 17.5 | 2.0 | 0.003 | 0.025 |
| SMD0805-350L /12V | K | 3.5 | 7.0 | 12.0 | 50.0 | 0.8 | 17.5 | 2.0 | 0.003 | 0.025 |
| SMD0805-380L | K | 3.8 | 7.6 | 6.0 | 50.0 | 0.8 | 19.0 | 2.0 | 0.003 | 0.020 |
| SMD0805-380L /12V | K | 3.8 | 7.6 | 12.0 | 50.0 | 0.8 | 19.0 | 2.0 | 0.003 | 0.020 |
| SMD0805-400L | K | 4.0 | 8.0 | 6.0 | 50.0 | 0.8 | 20.0 | 2.0 | 0.003 | 0.015 |
| SMD0805-400L /12V | K | 4.0 | 8.0 | 12.0 | 50.0 | 0.8 | 20.0 | 2.0 | 0.003 | 0.015 |





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Electrical Parameters

I hold= Hold current: maximum current device will pass without tripping in 25°C still air.

I trip= Trip current: minimum current at which the device will trip in 25°C still air.

V max= Maximum voltage device can withstand without damage at rated current (Imax)

I max= Maximum fault current device can withstand without damage at rated voltage (Vmax)

Pdtyp.= Power dissipated from device when in the tripped state at 25°C still air.

R min= Minimum resistance of device in initial (un-soldered) state.

R max= Maximum resistance of device in initial (un-soldered) state.

R 1max= Maximum resistance of device at 25°C measured one hour after tripping.

Temperature Rerating Chart-I hold (A)

| | Ambient Operation Temperature | | | | | | | | |
|-------------------|-------------------------------|-------|------|------|---------------|------|-------|------|------|
| Part Number | -40°C | -20°C | 0°C | 25°C | 40°C | 50°C | 60°C | 70°C | 85°C |
| | | | | Н | old Current (| (A) | | | |
| SMD0805-075L | 1.07 | 0.94 | 0.88 | 0.75 | 0.66 | 0.63 | 0.60 | 0.48 | 0.34 |
| SMD0805-075L /2V | 1.07 | 0.94 | 0.88 | 0.75 | 0.66 | 0.63 | 0.60 | 0.48 | 0.34 |
| SMD0805-110L | 1.57 | 1.38 | 1.29 | 1.10 | 0.98 | 0.92 | 0.88 | 0.71 | 0.50 |
| SMD0805-110L /12V | 1.57 | 1.38 | 1.29 | 1.10 | 0.98 | 0.92 | 0.88 | 0.71 | 0.50 |
| SMD0805-125L | 1.78 | 1.57 | 1.47 | 1.25 | 1.11 | 1.05 | 1.00 | 0.81 | 0.57 |
| SMD0805-125L /12V | 1.78 | 1.57 | 1.47 | 1.25 | 1.11 | 1.05 | 1.00 | 0.81 | 0.57 |
| SMD0805-150L | 2.14 | 1.88 | 1.76 | 1.50 | 1.33 | 1.25 | 1.20 | 0.97 | 0.68 |
| SMD0805-150L /12V | 2.14 | 1.88 | 1.76 | 1.50 | 1.33 | 1.25 | 1.20 | 0.97 | 0.68 |
| SMD0805-175L | 2. 50 | 2.19 | 2.05 | 1.75 | 1.55 | 1.46 | 1. 40 | 1.13 | 0.79 |
| SMD0805-175L /12V | 2.50 | 2.19 | 2.05 | 1.75 | 1.55 | 1.46 | 1.40 | 1.13 | 0.79 |
| SMD0805-200L | 2.85 | 2.51 | 2.35 | 2.00 | 1.77 | 1.67 | 1.60 | 1.29 | 0.91 |
| SMD0805-200L /12V | 2.85 | 2.51 | 2.35 | 2.00 | 1.77 | 1.67 | 1.60 | 1.29 | 0.91 |
| SMD0805-260L | 3.71 | 3.25 | 3.06 | 2.60 | 2.30 | 2.17 | 2.08 | 1.68 | 1.18 |
| SMD0805-260L /12V | 3.71 | 3.25 | 3.06 | 2.60 | 2.30 | 2.17 | 2.08 | 1.68 | 1.18 |
| SMD0805-300L | 4.29 | 3.75 | 3.53 | 3.00 | 2.65 | 2.50 | 2.40 | 1.94 | 1.36 |
| SMD0805-300L /12V | 4.29 | 3.75 | 3.53 | 3.00 | 2.65 | 2.50 | 2.40 | 1.94 | 1.36 |
| SMD0805-350L | 5.00 | 4.38 | 4.12 | 3.50 | 3.09 | 2.92 | 2.80 | 2.26 | 1.59 |
| SMD0805-350L /12V | 5.00 | 4.38 | 4.12 | 3.50 | 3.09 | 2.92 | 2.80 | 2.26 | 1.59 |
| SMD0805-380L | 5.43 | 4.76 | 4.47 | 3.80 | 3.35 | 3.17 | 3.04 | 2.45 | 1.73 |
| SMD0805-380L /12V | 5.43 | 4.76 | 4.47 | 3.80 | 3.35 | 3.17 | 3.04 | 2.45 | 1.73 |
| SMD0805-400L | 5.72 | 5.00 | 4.71 | 4.00 | 3.53 | 3.33 | 3.20 | 2.59 | 1.81 |
| SMD0805-400L /12V | 5.72 | 5.00 | 4.71 | 4.00 | 3.53 | 3.33 | 3.20 | 2.59 | 1.81 |



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Test Procedures and Requirement

| Test Item | Test Conditions | Accept/Reject Criteria |
|--------------------|-------------------------------|--------------------------|
| Initial Resistance | In still air at 25°C | RMIN ≤ R ≤ R1MAX |
| Time to Trip | Specified current, VMAX, 25°C | T ≤ Maximum Time to Trip |
| Hold Current | 30min, at IH, 25°C | No trip |
| Trip Endurance | VMAX, 1 hour | No arcing or burning |

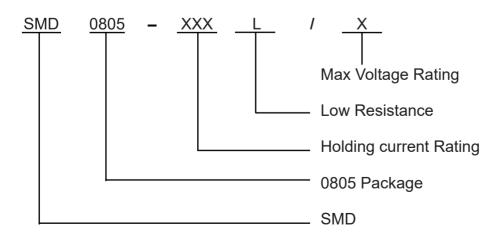
Physical Characteristics

| Terminal Materials | Tin-Plated Nickle-copper |
|----------------------|---|
| Soldering Zone | Meets EIA specification RS 186-9E and ANSIJ-STD-002 Category 3. |
| Moisture Sensitivity | Level 2a, per IPCJEDEC J-STD 020C |

Environmental Specifications

| Test Item | Test Conditions | Resistance Change |
|--------------------|---|-------------------|
| Passive Aging | 85°C,1000 hours | ±10% typical |
| Humidity Aging | 85°C/85%RH.100 hours | ±5% typical |
| Thermal Shock | MIL-STD 202,Method 107G +85°C/-40°C ,20 times | -30% typical |
| Solvent Resistance | MIL-STD-202,Method 215 | No change |
| Vibration | ML-STD-883C,Method 2007.1,Test Condition A | No change |

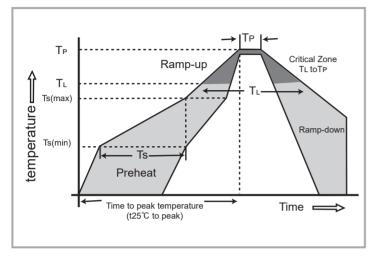
Part Numbering System





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Soldering Parameters



- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.
- Devices are not designed to be wave soldered to the bottom side of the board.
- ◆ Recommended maximum paste thickness is 0.25mm(0.010inch).
- Devices can be cleaned using standard industry methods and solvents.
- Soldering temperature profile meets RoHs lead free process.
 Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

| Reflow | Condition | Lead–free assembly | | |
|--|---|--------------------|--|--|
| | -Temperature Min (Ts _(min)) | 150°C | | |
| Pre Heat | -Temperature Max (Ts _(max)) | 200°C | | |
| | - Time (min to max) (Ts) | 60 -120 Seconds | | |
| | e ramp up rate (Liquidus L) to peak | 3°C/second max | | |
| Ts _(max) to TL - Ramp-up Rate | | 3°C/second max | | |
| Reflow | - Temperature (TL) (Liquidus) | 217°C | | |
| Kellow | - Time (min to max) (Ts) | 60 -150 Seconds | | |
| Peak Te | mperature (TP) | 260 +0/-5°C | | |
| | thin 5°C of actual peak ature (TP) | 30 Seconds | | |
| Ramp-d | lown Rate | 3°C/second max | | |
| Time 25 | °C to peak Temperature (TP) | 8 minutes Max | | |
| Do not | exceed | 260°C | | |

Caution:

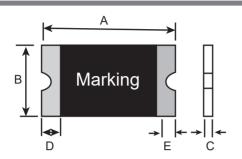
- 1. If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements
- 2. Operation beyond the specified rating may result in damage and possible arcing and flame.
- 3. PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.

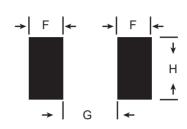




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Dimensions Unit: mm





| Doub Niveshou | | A | | 3 | (| | D | Е |
|-------------------|------|------|------|------|------|------|------|------|
| Part Number | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. |
| SMD0805-075L | 2.0 | 2.2 | 1.2 | 1.5 | 0.3 | 0.7 | 0.20 | 0.10 |
| SMD0805-075L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.3 | 0.7 | 0.20 | 0.10 |
| SMD0805-110L | 2.0 | 2.2 | 1.2 | 1.5 | 0.3 | 0.7 | 0.20 | 0.10 |
| SMD0805-110L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.3 | 0.7 | 0.20 | 0.10 |
| SMD0805-125L | 2.0 | 2.2 | 1.2. | 1.5 | 0.3 | 0.7 | 0.20 | 0.10 |
| SMD0805-125L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.3 | 0.7 | 0.20 | 0.10 |
| SMD0805-150L | 2.0 | 2.2 | 1.2 | 1.5 | 0.4 | 1.0 | 0.20 | 0.10 |
| SMD0805-150L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.4 | 1.0 | 0.20 | 0.10 |
| SMD0805-175L | 2.0 | 2.2 | 1.2 | 1.5 | 0.4 | 1.2 | 0.20 | 0.10 |
| SMD0805-175L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.4 | 1.2 | 0.20 | 0.10 |
| SMD0805-200L | 2.0 | 2.2 | 1.2 | 1.5 | 0.4 | 1.2 | 0.20 | 0.10 |
| SMD0805-200L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.4 | 1.2 | 0.20 | 0.10 |
| SMD0805-260L | 2.0 | 2.2 | 1.2 | 1.5 | 0.5 | 1.4 | 0.20 | 0.10 |
| SMD0805-260L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.5 | 1.4 | 0.20 | 0.10 |
| SMD0805-300L | 2.0 | 2.2 | 1.2 | 1.5 | 0.5 | 1.4 | 0.20 | 0.10 |
| SMD0805-300L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.5 | 1.4 | 0.20 | 0.10 |
| SMD0805-350L | 2.0 | 2.2 | 1.2 | 1.5 | 0.5 | 1.4 | 0.20 | 0.10 |
| SMD0805-350L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.5 | 1.4 | 0.20 | 0.10 |
| SMD0805-380L | 2.0 | 2.2 | 1.2 | 1.5 | 0.6 | 1.6 | 0.20 | 0.10 |
| SMD0805-380L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.6 | 1.6 | 0.20 | 0.10 |
| SMD0805-400L | 2.0 | 2.2 | 1.2 | 1.5 | 0.6 | 1.6 | 0.20 | 0.10 |
| SMD0805-400L /12V | 2.0 | 2.2 | 1.2 | 1.5 | 0.6 | 1.6 | 0.20 | 0.10 |

Layout Dimensions Unit: mm

| Part Number | F | G | Н | |
|-----------------|--------------|--------------|--------------|--|
| i art Number | Normal Value | Normal Value | Normal Value | |
| SMD0805L Series | 1.0 ± 0.1 | 1.2 ± 0.1 | 1.5 ± 0.1 | |





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Ordering Information

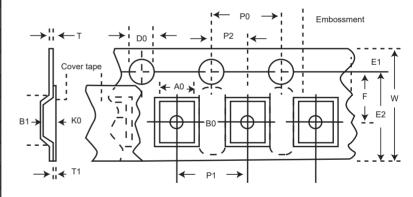
| Part Number | Quantity | Part Number | Quantity |
|-------------------|----------------|-------------------|----------------|
| SMD0805-075L | 5,000 pcs/Reel | SMD0805-200L /12V | 4,000 pcs/Reel |
| SMD0805-075L /12V | 5,000 pcs/Reel | SMD0805-260L | 3,000 pcs/Reel |
| SMD0805-110L | 5,000 pcs/Reel | SMD0805-260L /12V | 3,000 pcs/Reel |
| SMD0805-110L /12V | 5,000 pcs/Reel | SMD0805-300L | 3,000 pcs/Reel |
| SMD0805-125L | 5,000 pcs/Reel | SMD0805-300L /12V | 3,000 pcs/Reel |
| SMD0805-125L /12V | 5,000 pcs/Reel | SMD0805-350L | 3,000 pcs/Reel |
| SMD0805-150L | 5,000 pcs/Reel | SMD0805-350L /12V | 3,000 pcs/Reel |
| SMD0805-150L /12V | 5,000 pcs/Reel | SMD0805-380L | 3,000 pcs/Reel |
| SMD0805-175L | 4,000 pcs/Reel | SMD0805-380L /12V | 3,000 pcs/Reel |
| SMD0805-175L /12V | 4,000 pcs/Reel | SMD0805-400L | 3,000 pcs/Reel |
| SMD0805-200L | 4,000 pcs/Reel | SMD0805-400L /12V | 3,000 pcs/Reel |

Tape Specification and Reel Specifications

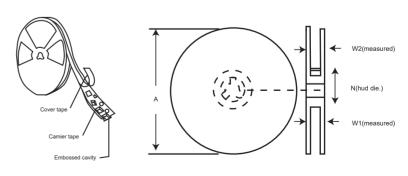
| Coverning Specifications EIA 481-1(Unit:mm) | | | | |
|--|-----------|--|--|--|
| W | 8.00±0.10 | | | |
| P0 | 4.00±0.10 | | | |
| P1 | 4.00±0.10 | | | |
| P2 | 2.00±0.05 | | | |
| A0 | 0.95±0.10 | | | |
| В0 | 1.85±0.10 | | | |
| D0 | 1.55±0.05 | | | |
| F | 3.50±0.05 | | | |
| E1 | 1.75±0.10 | | | |
| Т | 0.25±0.02 | | | |
| Leader min. | 390 | | | |
| Traile min. | 160 | | | |

| Reel Dimensions | | | | | |
|-----------------|----------------|--|--|--|--|
| A | 178±1.0 | | | | |
| N | 59±1.0 | | | | |
| W1 | 8.5 + 1.0/-0.2 | | | | |
| W2 | 12.0±1.0 | | | | |

ELA Tape Component Dimentions



EIA Reel Dimentions





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